Multilayer Ceramic Chip Capacitors

C1005NP01H060D050BA





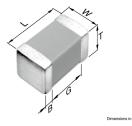


1 of 3 Creation Date : July 06, 2017 (GMT)



TDK item description C1005NP01H060DT****

Applications	Commercial Grade Please refer to Part No. CGA2B2NP01H060D050BA for Automotive use.	
Feature	150°C High Temperature Application	
Series	C1005 [EIA 0402]	
Status	Production	



	Size	
Length(L)	1.00mm ±0.05mm	
Width(W)	0.50mm ±0.05mm	
Thickness(T)	0.50mm ±0.05mm	
Terminal Width(B)	0.10mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.30mm to 0.50mm	
Recommended Land Pattern (PB)	0.35mm to 0.45mm	
Recommended Land Pattern (PC)	0.40mm to 0.60mm	

Electrical Characteristics		
Capacitance	6pF ±0.5pF	
Rated Voltage	50VDC	
Temperature Characteristic	NP0(0±30ppm/°C)	
Q (Min.)	520	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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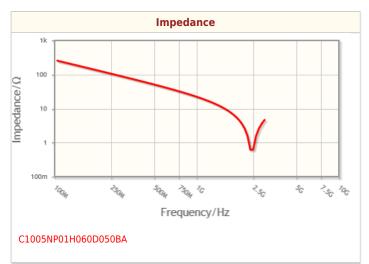


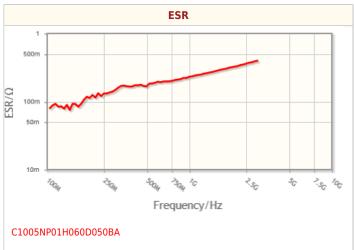


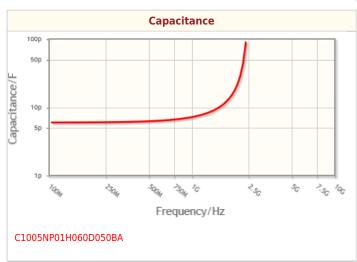


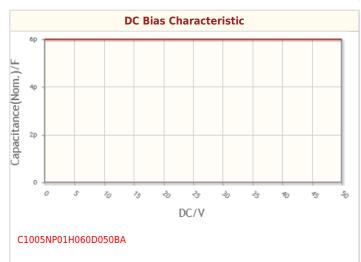


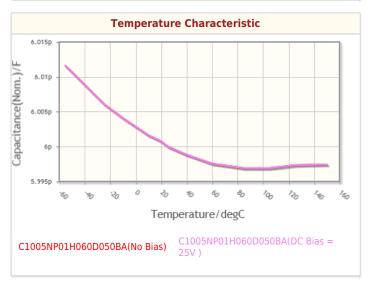
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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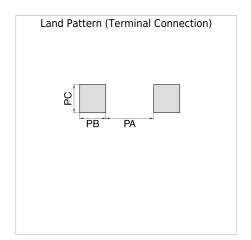








Associated Images



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